



FOR IMMEDIATE RELEASE

## Press Release

### **YINCAE Advanced Materials Wins Global Technology Award at Productronica for World's First Solder Joint Encapsulant**

November 18, 2015

**Albany, NY** – YINCAE Advanced Materials, LLC is proud to announce that our company was awarded the 2015 Global Technology Award in the adhesives, coatings, and encapsulants category! This ceremony took place on Tuesday, November 10<sup>th</sup> at the Productronica Global Exhibition in Munich, Germany.

YINCAE Solder Joint Encapsulant was recognized as one of the products that made the greatest impact on the electronics industry in the years 2014 and 2015. YINCAE SJE replaces flux in the manufacturing process, and removes the need for underfill. After curing, the adhesive encases each individual solder ball, leaving only air in between the balls. Our product has been proven to have better reliability, better thermal cycling performance, and easy reworkability.

#### **About Global Technology Awards**

The Global Technology Awards are universally recognized as the most international industry award, attracting entries from Europe, USA and Asia. Each year the Global Technology Awards recognize the latest innovations in production equipment and materials for the EMS industry by a distinguished panel of industry experts.

#### **About YINCAE Advanced Materials, LLC**

Founded in 2005, and headquartered in Albany, New York, YINCAE Advanced Materials is a leading manufacturer and supplier of high-performance coatings, adhesives, and electronics materials used in electronic and optoelectronic devices. YINCAE products provide innovative solutions to support manufacturing processes from wafer level, to package level, to board level, and in final devices.

#### **FOR ADDITIONAL INFORMATION CONTACT:**

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